WinhiSemi

VTGA066N02TA

Datasheet



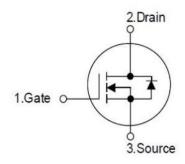
17mΩ, 20V, N-Channel Power MOSFET

VTGA066N02TA

General Description

VTGA066N02TA N-Channel MOSFET is based on unique device design to achieve low RDS_(ON), low gate charge, fast switching and excellent avalanche characteristics.

Symbol



Symbol of VTGA066N02TA

Features

- Low RDS(ON) & FOM
- $\blacksquare R_{DS(ON) max} = 17m\Omega@V_{GS} = 4.5V$
- Extremely low switching loss
- Fast switching and soft recovery

Package Type



Application

- Charging Circuit
- Battery Applications
- Synchronous Rectification
- High Frequency Switching

Package Type of VTGA066N02TA

Ordering Information

Product Name	Package	Marking
VTGA066N02TA	DFN3*3	66N02

17mΩ, 20V, N-Channel Power MOSFET

VTGA066N02TA

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V _{GS}	±8	V
Continuous Drain Current ^{Note 1} , T _C =25°C	I_D	22	A
Pulsed Drain Current ^{Note 2}	I_{DM}	66	A
Max Power Dissipation Note 3, T _C =25°C	P _D	19.4	W
Avalanche Current, Single Pulse Note 5	I _{AS}	14	A
Avalanche Energy, Single Pulse Note 5	Eas	29.4	mJ
Operation Junction temperature	T _J	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		6.45		°C/W
Thermal Resistance, Junction-to-Ambient ^{Note4}	t^{Note4} $R_{\theta JA}$ 62] -C/W	

Notes:

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_D is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.
- 5) V_{DS} =15V, V_{GS} =4.5V, L=0.3mH, Rg=25 Ω , starting T_{J} =25 °C.

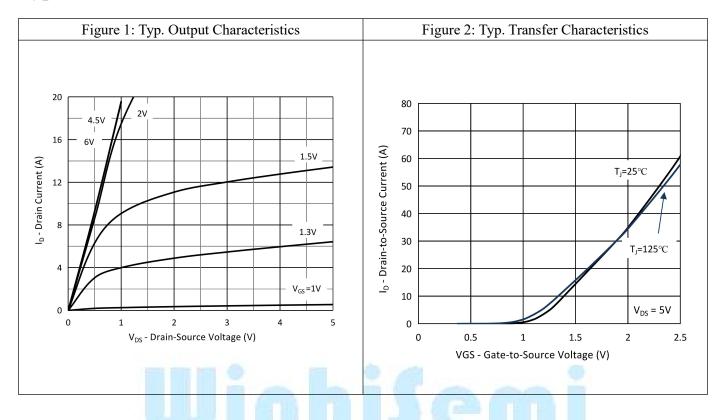
$17m\Omega$, 20V, N-Channel Power MOSFET

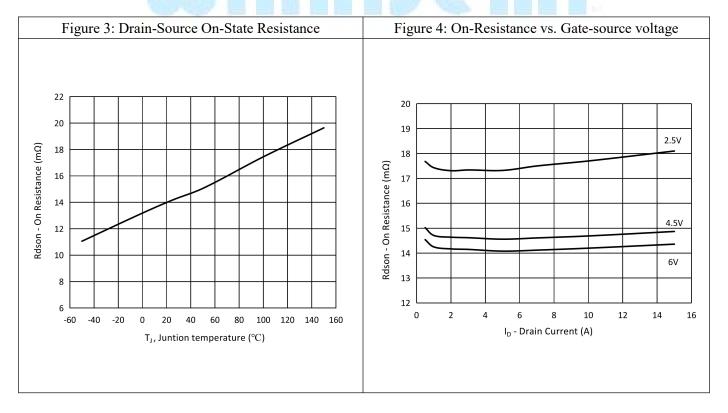
VTGA066N02TA

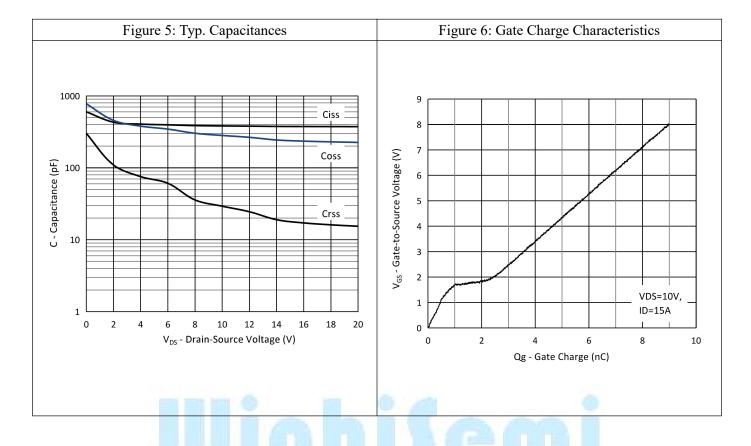
Electrical Characteristics (T_J= 25 °C, unless otherwise specified)

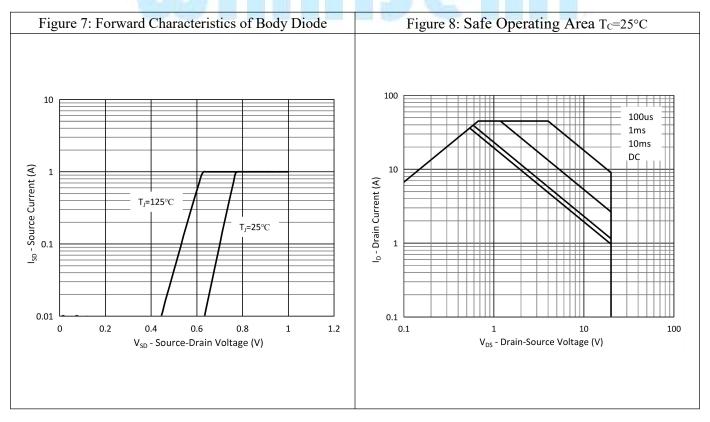
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Statistic Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	20			V	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$			1	uA	
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$			±100	nA	
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250uA	0.4	0.6	0.9	V	
Static Drain-Source On-Resistance	D	V_{GS} =4.5V, I_{D} =5A		14	17	$m\Omega$	
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =15A		14	17	mΩ	
Gate Resistance	R_G	f=1MHz, open drain		2.37		Ω	
Dynamic Characteristics							
Input Capacitance	Ciss	V _{GS} =0V		383		pF	
Output Capacitance	Coss	$V_{DS}=10V$		282.2		pF	
Reverse Transfer Capacitance	C _{rss}	f=1MHz		29.3		pF	
Turn-on Delay Time	t _{d(on)}	V _{DS} =15V		5.4			
Rise Time	$t_{\rm r}$	$V_{GS}=4.5V$		2.4			
Turn-off Delay Time	t _{d(off)}	$I_D=6A$		17.2		ns	
Fall Time	t_{f}	$R_G=3\Omega$		4			
Switching Characteristics							
Total Gate Charge (@VGS=8V)	Qg	V 04-0V		9			
Total Gate Charge (@VGS=4.5V)	Qg	V_{GS} =0 to 8V V_{DS} =10V		5.22		nC	
Gate to Source Charge	Q_{gs}	$I_{D}=15A$	1	0.79		IIC .	
Gate to Drain Charge	Q_{gd}	1D-13A		1.41			
Reverse Diode Characteristics							
Drain-Source Diode Forward Voltage	V_{SD}	V _{GS} =0V, I _{SD} =12A		0.89	1.2	V	
Reverse Recovery Time	t _{rr}	V _{DS} =10V		21.8		ns	
Reverse Recovery Charge	Qrr	$I_F=12A$		12.67		nC	
Peak Reverse Recovery Current	I _{rrm}	di/dt=100A/us		1.09		A	

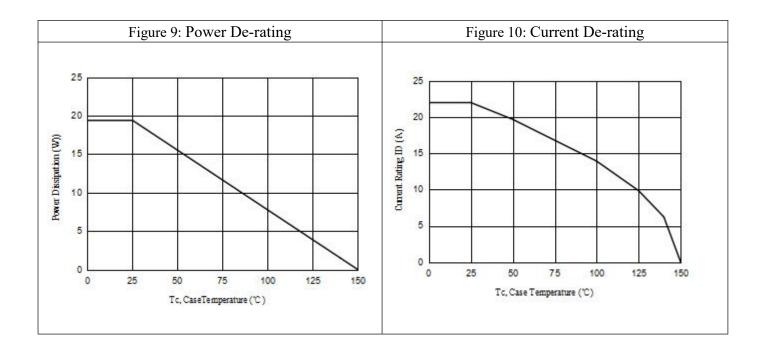
Typical Performance Characteristics

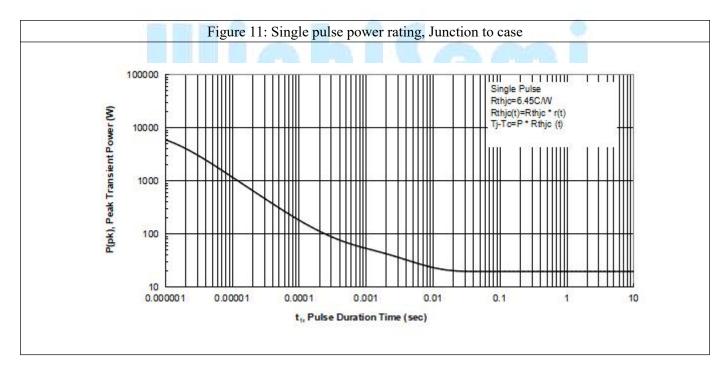


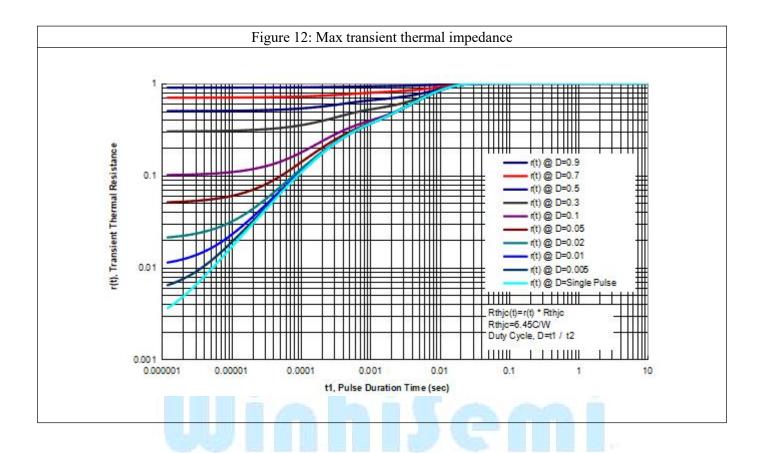




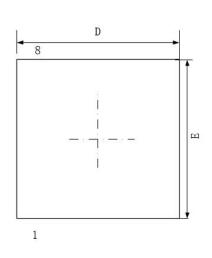


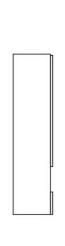


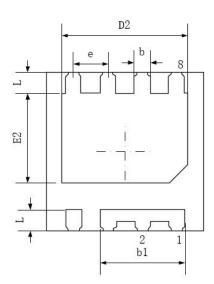


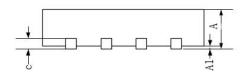


Mechanical Dimensions (DFN3*3 Unit:mm)









SYMBOL	MILLMETER			
	MIN	NOM	MAX	
А	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
b	0.25	0.30	0.35	
b1	1.55	1.60	1.65	
С	0.19	0.20	0.21	
D	2.90	3.00	3.10	
D2	2.30	2.40	2.50	
Е	2.90	3.00	3.10	
E2	1.60	1.70	1.80	
е	0.65BSC			
L	0.35	0.40	0.45	

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